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To: Examiner Tu-Tu Ho  Technology Center 2800	Total Pages Sent: 13  (including cover sheet)
Facsimile Number: 703-872-9306	Transmission Date: July 1, 2005

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Applicant: Bao, et al.	Docket No.: TSM03-0927
Serial No: 10/800,510	Art Unit: 2818
Date Filed: March 15, 2004	
Title: Semiconductor Device Having a Second Level of Metallization Formed over a First Level with Minimal Damage to the First Level and Method	

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- Certification of Facsimile Transmission (1 page)
- Response to Office Action (12 pages), to include:
  - Amendment (11 pages)
  - Drawing Sheet for New Figure 2g (1 page)

Respectfully submitted,

*Natalie Swider*  
 Natalie Swider  
 Legal Assistant

Confirmation Respectfully Requested

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JUL 01 2005Applicants: Bao, *et al.*

Docket No.: TSM03-0927

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Filed: March 15, 2004

Examiner: Tu-Tu Ho

For: Semiconductor Device Having a Second Level of Metallization Formed  
over a First Level with Minimal Damage to the First Level and Method

Mail Stop: Amendment  
Commissioner for Patents  
P. O. Box 1450  
Alexandria, VA 22313-1450

AMENDMENT

Dear Sir:

The following amendments and remarks are presented in response to the Examiner's Office Action mailed April 1, 2005. Please amend the above-referenced application as follows.

TSM03-0927

Page 1 of 11

Amendment